APPROVAL SHEET

MODEL NO.：_____

CUSTOMER：

CUSTOMER'S APPROVAL：

AUTHORIZED SIGNATURE/STAMP DATE

MANUFACTURER:

The Fourth Industrial Zone,Luokeng Village, Xiaotie District, Xiaojinkou Town, Huizhou City, Guangdong Province, China
Tel: 0752-7213069/7213070
Fax: 0752-7213065

Submitted by:
Approved by:
Date:

Performance Specification

Model	Marking	V_{max} (Vdc)	I_{max} (A)	I_{hold} @25°C (A)	I_{trip} @25°C (A)	P_d Typ. (W)	Maximum Time To Trip		Resistance		认证
							Current (A)	Time (Sec)	$R_{i\ min}$ (Ω)	$R1_{max}$ (Ω)	UL
SMD0805R005SF	1	15.0	30	0.05	0.15	0.5	0.5	1.50	1.500	18.000	√
SMD0805R005SF30V	1	30.0	30	0.05	0.15	0.5	0.5	1.50	1.500	18.000	
SMD0805R010SF	1	15.0	30	0.10	0.30	0.5	0.5	1.50	0.750	6.000	√
SMD0805R010SF30V	1	30.0	30	0.10	0.30	0.5	0.5	1.50	0.750	6.000	
SMD0805R020SF	2	9.0	30	0.20	0.50	0.5	8.0	0.02	0.550	3.500	√
SMD0805R020SF12V	2	12.0	30	0.20	0.50	0.5	8.0	0.02	0.550	3.500	
SMD0805R020SF16V	2	16.0	30	0.20	0.50	0.5	8.0	0.02	0.550	3.500	
SMD0805R035SF	3	6.0	30	0.35	0.75	0.5	8.0	0.10	0.200	1.200	√
SMD0805R035SF12v	3	12.0	30	0.35	0.75	0.5	8.0	0.10	0.200	1.200	
SMD0805R035SF13.2v	3	13.2	30	0.35	0.75	0.5	8.0	0.10	0.200	1.200	
SMD0805R035SF16v	3	16.0	30	0.35	0.75	0.5	8.0	0.10	0.200	1.200	
SMD0805R050SF	5	6.0	30	0.50	1.00	0.5	8.0	0.10	0.100	0.850	√
SMD0805R050SF12v	5	12.0	30	0.50	1.00	0.5	8.0	0.10	0.100	0.850	
SMD0805R050SF16v	5	16.0	30	0.50	1.00	0.5	8.0	0.10	0.100	0.850	
SMD0805R050SF24v	5	24.0	30	0.50	1.00	0.5	8.0	0.10	0.100	0.850	
SMD0805R075SF	7	6.0	35	0.75	1.50	0.6	8.0	0.20	0.070	0.385	√
SMD0805R075SF12v	7	12.0	35	0.75	1.50	0.6	8.0	0.20	0.070	0.385	
SMD0805R100SF	0	6.0	35	1.00	1.95	0.6	8.0	0.30	0.040	0.230	√
SMD0805R100SF12v	0	12.0	35	1.00	1.95	0.6	8.0	0.30	0.040	0.230	
SMD0805R110SF	0	6.0	35	1.10	2.20	0.6	8.0	0.30	0.035	0.210	√
SMD0805R110SF12v	0	12.0	35	1.10	2.20	0.6	8.0	0.30	0.035	0.210	
SMD0805R125SF	12	6.0	35	1.25	2.50	1.5	8.0	0.60	0.025	0.140	√
SMD0805R150SF	15	6.0	35	1.50	3.00	1.0	8.0	0.50	0.015	0.130	√

V max = Maximum operating voltage device can withstand without damage at rated current (Imax).

I max = Maximum fault current device can withstand without damage at rated voltage (V max).

I hold = Hold Current. Maximum current device will not trip in 25°C still air.

I trip = Trip Current. Minimum current at which the device will always trip in 25°C still air.

Pd = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.

Ri min/max = Minimum/Maximum device resistance prior to tripping at 25°C.

R1max = Maximum device resistance is measured one hour post reflow.

CAUTION : Operation beyond the specified ratings may result in damage and possible arcing and flame.

Environmental Specifications

Test	Conditions	Resistance change
Passive aging	+85°C, 1000 hrs.	±5% typical
Humidity aging	+85°C, 85% R.H. , 168 hours	±5% typical
Thermal shock	+85°C to -40°C, 20 times	±33% typical
Resistance to solvent	MIL-STD-202,Method 215	No change

Vibration	MIL-STD-202,Method 201	No change
Ambient operating conditions : - 40 °C to +85 °C		
Maximum surface temperature of the device in the tripped state is 125 °C		

Agency Approval and Environmental Complianc

Agency	File Number
UL	E486890
TUV	pending

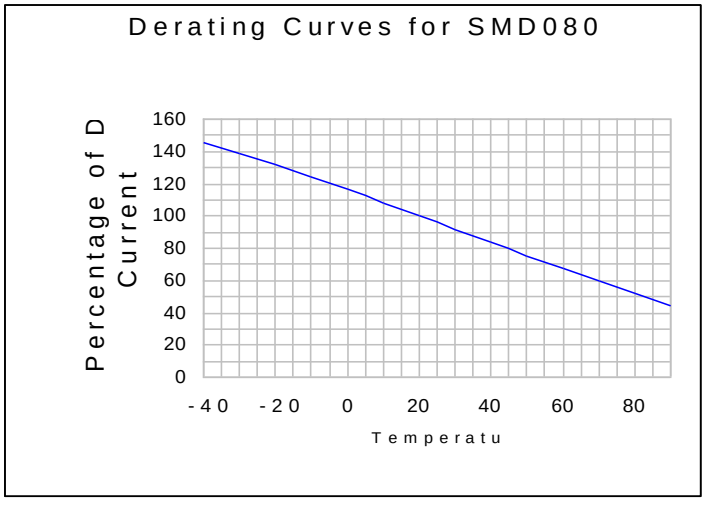
Regulation	Standard
Pb RoHS	2011/65/EU
HF	EN14582

Thermal Derading Chart

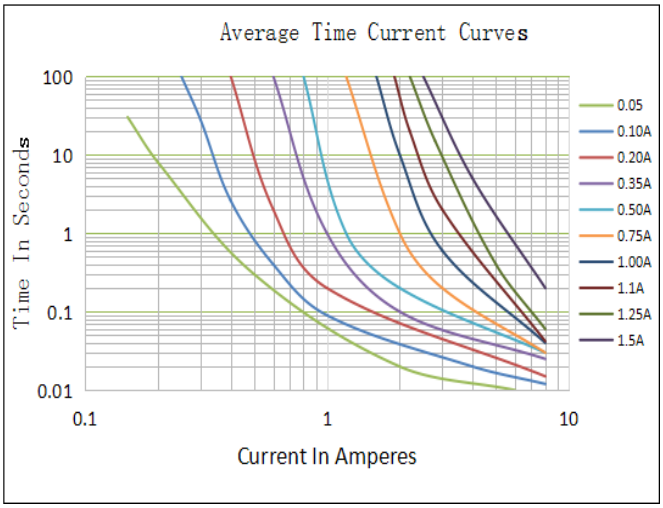
Recommended Hold Current(A) at Ambient Temperature(°C)

Model	Ambient Operation Temperature								
	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
SMD0805R005SF	0.070	0.060	0.055	0.050	0.040	0.035	0.030	0.025	0.015
SMD0805R010SF	0.14	0.12	0.11	0.10	0.08	0.07	0.06	0.05	0.03
SMD0805R020SF	0.28	0.25	0.23	0.20	0.17	0.14	0.12	0.10	0.07
SMD0805R035SF	0.47	0.44	0.39	0.35	0.30	0.27	0.24	0.20	0.14
SMD0805R050SF	0.68	0.62	0.55	0.50	0.40	0.37	0.33	0.29	0.23
SMD0805R075SF	1.00	0.90	0.79	0.75	0.63	0.57	0.53	0.41	0.34
SMD0805R100SF	1.35	1.25	1.15	1.00	0.82	0.74	0.65	0.55	0.42
SMD0805R110SF	1.45	1.35	1.20	1.10	0.92	0.84	0.75	0.65	0.52
SMD0805R125SF	1.65	1.53	1.36	1.25	1.05	0.95	0.85	0.74	0.59
SMD0805R150SF	1.98	1.84	1.63	1.50	1.26	1.14	1.02	0.88	0.71

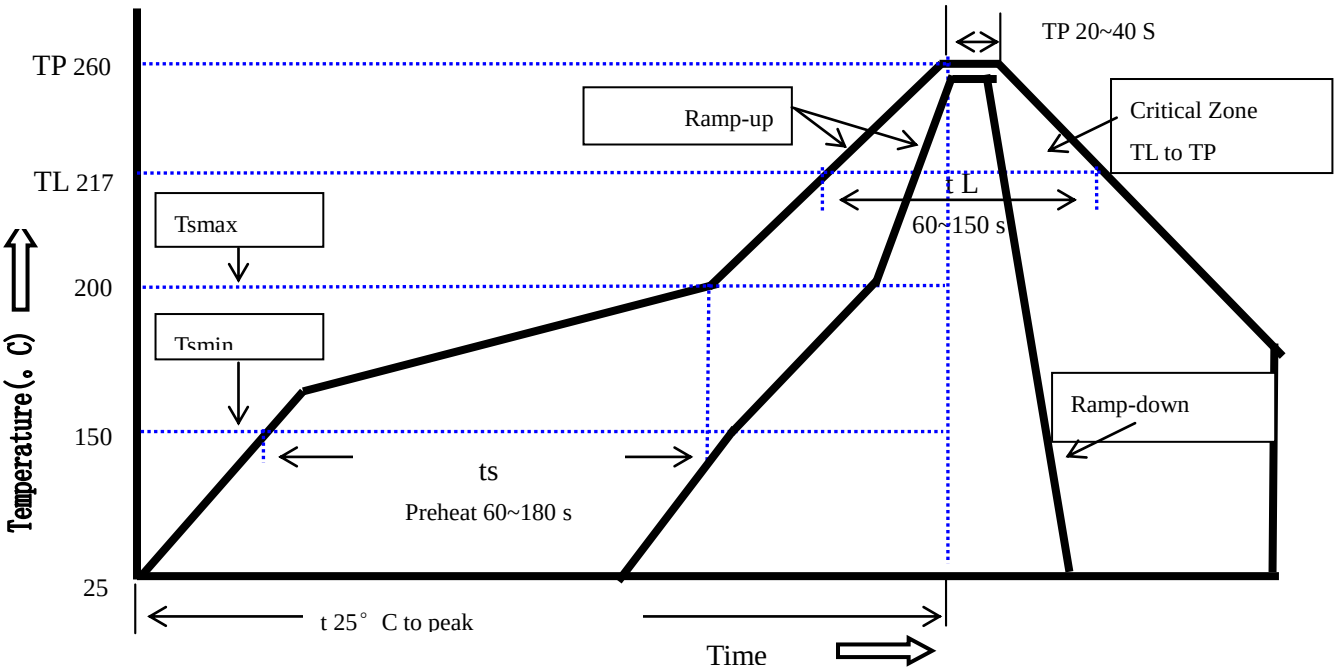
Thermal Derating Curve



Average Time-Current Curve



Soldering Parameters



Profile Feature	Pb-Free Assembly
Average Ramp-Up Rate(Ts max to T p)	3℃/second mac.
Preheat	
-Temperature Min(Ts min)	150℃
-Temperature Max(Ts max)	200℃
-Time(Ts min to Ts max)	60~180 seconds
Time maintained above:	
-Temperature(TL)	217℃
-Time(tL)	60~150 seconds
Peak Temperature(Tp)	260℃
Ramp-Down Rate	6℃/second max.
Time 25℃ to Peak Temperature	8 minutes max
Storage Condition	0℃~30℃,30%-60%RH

Recommended reflow methods: IR, vapor phase oven, hot air oven, N2 environment for lead-free

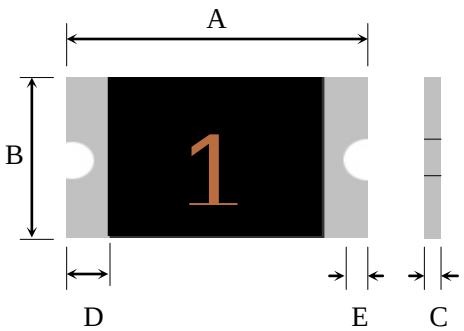
Recommended maximum paste thickness is 0.25mm

Devices can be cleaned using standard industry methods and solvents.

Note 1:All temperature refer to topside of the package, measured on the package body surface.

Note 2: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

Physical Dimensions(mm.)



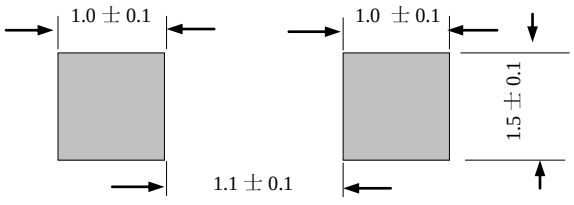
型號	A		B		C		D	E
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.
SMD0805R005SF	2.00	2.20	1.20	1.50	0.40	0.90	0.20	0.10
SMD0805R005SF30V	2.00	2.20	1.20	1.50	0.40	0.90	0.20	0.10
SMD0805R010SF	2.00	2.20	1.20	1.50	0.40	0.90	0.20	0.10
SMD0805R010SF30V	2.00	2.20	1.20	1.50	0.40	0.90	0.20	0.10
SMD0805R020SF	2.00	2.20	1.20	1.50	0.35	0.80	0.20	0.10
SMD0805R020SF12V	2.00	2.20	1.20	1.50	0.35	0.80	0.20	0.10
SMD0805R020SF16V	2.00	2.20	1.20	1.50	0.35	0.80	0.20	0.10
SMD0805R035SF	2.00	2.20	1.20	1.50	0.35	0.80	0.20	0.10
SMD0805R035SF12v	2.00	2.20	1.20	1.50	0.35	0.80	0.20	0.10
SMD0805R035SF13.2v	2.00	2.20	1.20	1.50	0.35	0.80	0.20	0.10
SMD0805R035SF16v	2.00	2.20	1.20	1.50	0.35	0.80	0.20	0.10
SMD0805R050SF	2.00	2.20	1.20	1.50	0.35	0.80	0.20	0.10
SMD0805R050SF12v	2.00	2.20	1.20	1.50	0.35	0.80	0.20	0.10
SMD0805R050SF16v	2.00	2.20	1.20	1.50	0.50	1.10	0.20	0.10
SMD0805R050SF24v	2.00	2.20	1.20	1.50	0.50	1.10	0.20	0.10
SMD0805R075SF	2.00	2.20	1.20	1.50	0.50	1.00	0.20	0.10
SMD0805R075SF12v	2.00	2.20	1.20	1.50	0.50	1.00	0.20	0.10
SMD0805R100SF	2.00	2.20	1.20	1.50	0.70	1.20	0.20	0.10
SMD0805R100SF12v	2.00	2.20	1.20	1.50	0.70	1.20	0.20	0.10
SMD0805R110SF	2.00	2.20	1.20	1.50	0.70	1.20	0.20	0.10
SMD0805R110SF12v	2.00	2.20	1.20	1.50	0.70	1.20	0.20	0.10
SMD0805R125SF	2.00	2.20	1.20	1.50	0.70	1.50	0.20	0.10
SMD0805R150SF	2.00	2.20	1.20	1.50	0.70	1.50	0.20	0.10

Termination Pad Characteristics

Terminal pad materials：Tin-plated Nickel-Copper

Terminal pad solder ability：Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

Recommended Pad Layout (mm.)



Packaging Quantity

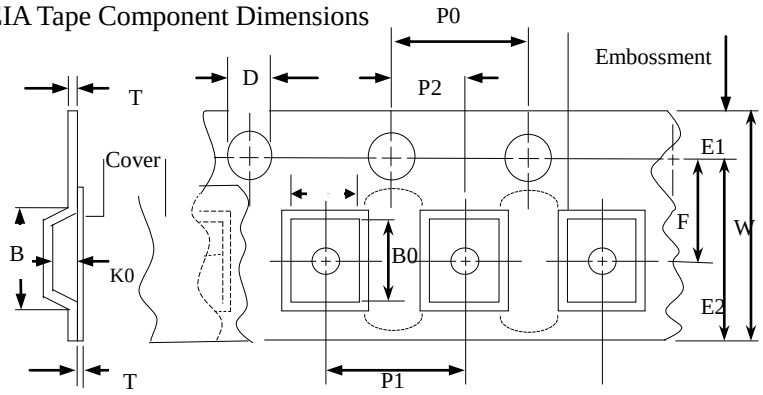
Part Number	Quantity
SMD0805R005.010.020.035.050.SF	5,000 pcs/reel
SMD0805R075.100.110SF	4,000 pcs/reel
SMD0805R125.150SF	3,500 pcs/reel

Tape & reel packaging per EIA481-1

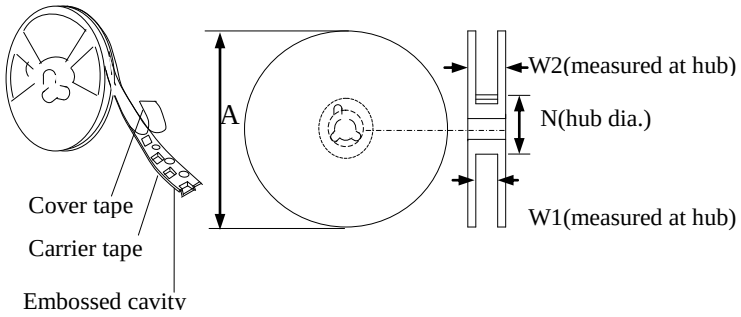
Tape And Reel Specifications (mm)

Governing Specifications	EIA 481-1
W	8.0 ± 0.3
P0	4.0 ± 0.10
P1	4.0 ± 0.10
P2	2.0 ± 0.05
A0	1.45 ± 0.10
B0	2.30 ± 0.10
B1max.	4.35
D0	1.55 + 0.1, -0
F	3.5 ± 0.05
E1	1.75 ± 0.10
E2min.	6.25
T	0.25
T1max.	0.1
K0	0.74 ± 0.1
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	178
N min.	60
W1	9.0 ± 0.5
W2	12.0 ± 0.05

EIA Tape Component Dimensions



EIA Reel Dimensions



Storage And Handling

· Storage conditions：30°C max, 30%-60% R.H.

· Devices may not meet specified performance if storage conditions are exceeded.

Part Number System

SMD 0805 R □□□ S F □□ V

- special voltage Rating(Optional)
- Lead-Free
- Tin-plated Nickel-Copper
- Holding Current Rating
- Da Rong
- Device Dimensions: Length/width(Unit:1/100 inch) Size 2012 mm / 0805 inch
- Surface Mount Device